



512K x 8 Static RAM

Features

- **Voltage Range**
— 4.5V–5.5V
- **Low active power**
— Typical active current: 2.5 mA @ f = 1 MHz
— Typical active current: 12.5 mA @ f = f_{max}
- **Low standby current**
- **Automatic power-down when deselected**
- **TTL-compatible inputs and outputs**
- **Easy memory expansion with CE and OE features**
- **CMOS for optimum speed/power**

Functional Description

The WCMA4008C1X is a high-performance CMOS static RAM organized as 512K words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable (\overline{CE}), an active

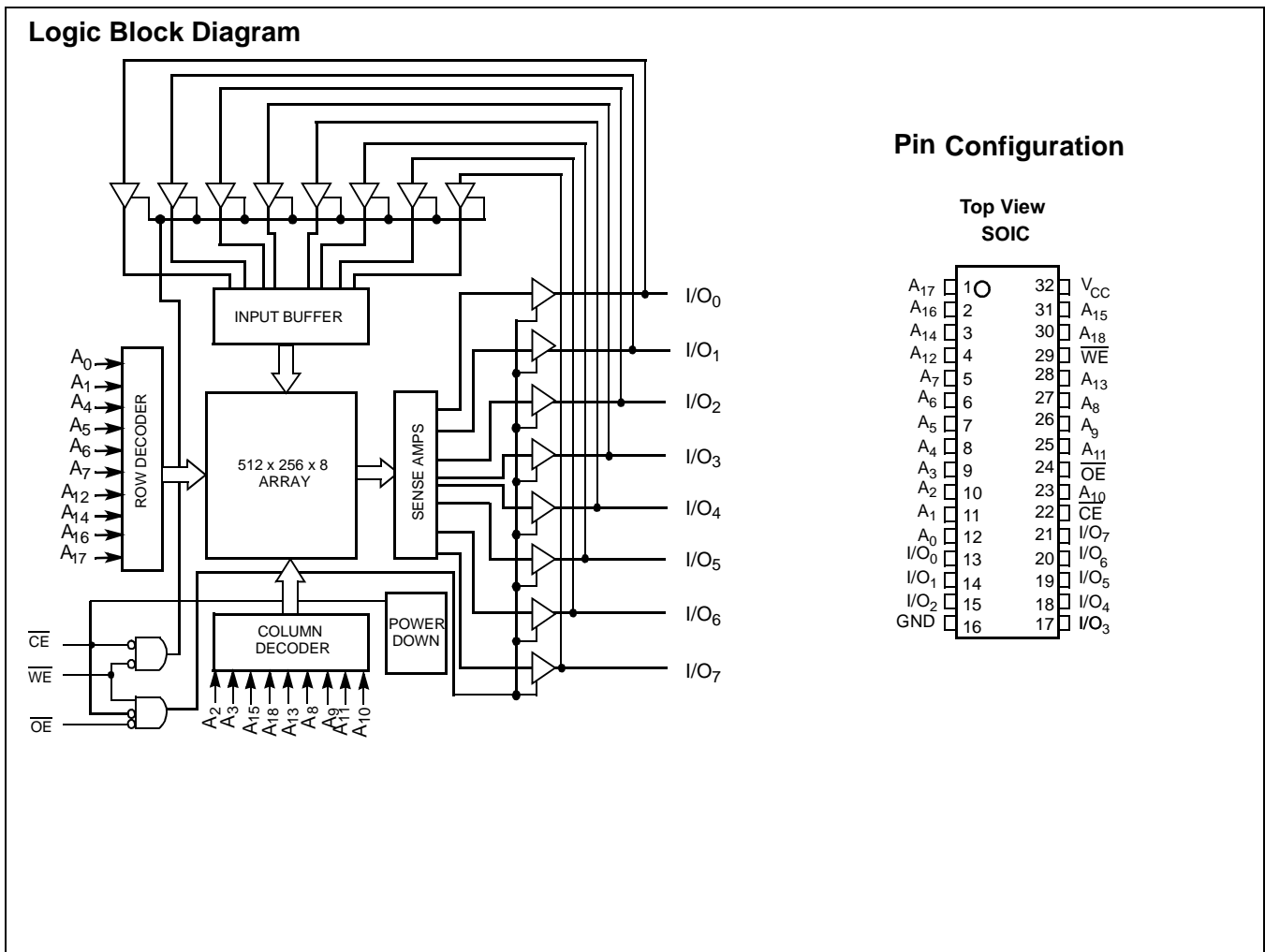
LOW Output Enable (\overline{OE}), and three-state drivers. This device has an automatic power-down feature that reduces power consumption by more than 99% when deselected.

Writing to the device is accomplished by taking Chip Enable (\overline{CE}) and Write Enable (\overline{WE}) inputs LOW. Data on the eight I/O pins (I/O_0 through I/O_7) is then written into the location specified on the address pins (A_0 through A_{18}).

Reading from the device is accomplished by taking Chip Enable (\overline{CE}) and Output Enable (\overline{OE}) LOW while forcing Write Enable (\overline{WE}) HIGH for read. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O_0 through I/O_7) are placed in a high-impedance state when the device is deselected (\overline{CE} HIGH), the outputs are disabled (\overline{OE} HIGH), or during a write operation (\overline{CE} LOW, and \overline{WE} LOW).

The WCMA4008C1X is available in a standard 32-pin 450-mil-wide body width SOIC.





Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

- Storage Temperature -65°C to +150°C
- Ambient Temperature with
Power Applied..... -55°C to +125°C
- Supply Voltage on V_{CC} to Relative GND -0.5V to +7.0V
- DC Voltage Applied to Outputs
in High Z State^[1] -0.5V to V_{CC} +0.5V
- DC Input Voltage^[1]..... -0.5V to V_{CC} +0.5V
- Current into Outputs (LOW) 20 mA
- Static Discharge Voltage..... 2001V
(per MIL-STD-883, Method 3015)
- Latch-Up Current >200 mA

Product Portfolio

Product	V _{CC} Range			Speed	Temp.	Power Dissipation			
						Operating, I _{CC}		Standby (I _{SB2})	
						f = f _{max}		Typ. ^[2]	Max.
	Min.	Typ.	Max.			Typ. ^[3]	Max.		
WCMA4008C1X	4.5 V	5.0V	5.5V	70 ns	Ind'l	12.5 mA	20 mA	4 μA	20 μA

Operating Range

Range	Ambient Temperature	V _{CC}
Industrial	-40°C to +85°C	4.5V-5.5V

Notes:

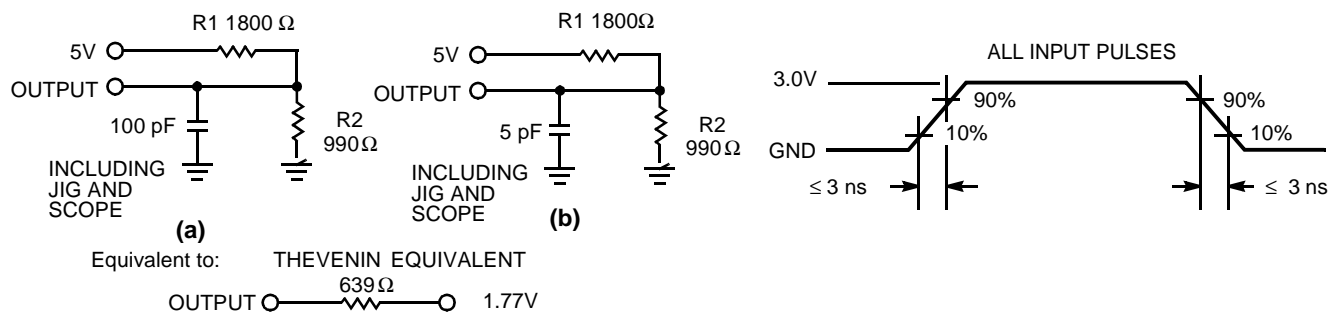
1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
2. Typical values are measured at V_{CC} = 5V, T_A = 25°C, and are included for reference only and are not tested or guaranteed.

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	WCMA4008C1X			Unit
			Min.	Typ. ^[2]	Max.	
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OH} = -1 mA	2.4			V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 2.1 mA			0.4	V
V _{IH}	Input HIGH Voltage		2.2		V _{CC} +0.3	V
V _{IL}	Input LOW Voltage		-0.3		0.8	V
I _{IX}	Input Leakage Current	GND ≤ V _I ≤ V _{CC}	-1		+1	μA
I _{OZ}	Output Leakage Current	GND ≤ V _I ≤ V _{CC} , Output Disabled	-1		+1	μA
I _{CC}	V _{CC} Operating Supply Current	f = f _{MAX} = 1/t _{RC}		12.5	20	mA
		f = 1 MHz	I _{OUT} = 0 mA V _{CC} = Max.,	2.5		mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	Max. V _{CC} , $\overline{CE} \geq V_{IH}$ V _{IN} ≥ V _{IH} or V _{IN} ≤ V _{IL} , f = f _{MAX}			1.5	mA
I _{SB2}	Automatic CE Power-Down Current —CMOS Inputs	Max. V _{CC} , $\overline{CE} \geq V_{CC} - 0.3V$, V _{IN} ≥ V _{CC} - 0.3V, or V _{IN} ≤ 0.3V, f = 0		4	20	μA

Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	6	pF
C _{OUT}	Output Capacitance		8	pF

AC Test Loads and Waveforms

Note:

3. Tested initially and after any design or process changes that may affect these parameters.

Switching Characteristics^[4] Over the Operating Range

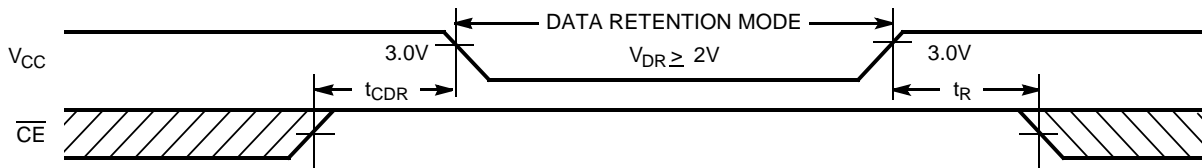
Parameter	Description	WCMA4008C1X		Unit
		Min.	Max.	
READ CYCLE				
t_{RC}	Read Cycle Time	70		ns
t_{AA}	Address to Data Valid		70	ns
t_{OHA}	Data Hold from Address Change	10		ns
t_{ACE}	\overline{CE} LOW to Data Valid		70	ns
t_{DOE}	\overline{OE} LOW to Data Valid		35	ns
t_{LZOE}	\overline{OE} LOW to Low Z ^[5]	5		ns
t_{HZOE}	\overline{OE} HIGH to High Z ^[5, 6]		25	ns
t_{LZCE}	\overline{CE} LOW to Low Z ^[5]	10		ns
t_{HZCE}	\overline{CE} HIGH to High Z ^[5, 6]		25	ns
t_{PU}	\overline{CE} LOW to Power-Up	0		ns
t_{PD}	\overline{CE} HIGH to Power-Down		70	ns
WRITE CYCLE^[7]				
t_{WC}	Write Cycle Time	70		ns
t_{SCE}	\overline{CE} LOW to Write End	60		ns
t_{AW}	Address Set-Up to Write End	60		ns
t_{HA}	Address Hold from Write End	0		ns
t_{SA}	Address Set-Up to Write Start	0		ns
t_{PWE}	\overline{WE} Pulse Width	55		ns
t_{SD}	Data Set-Up to Write End	30		ns
t_{HD}	Data Hold from Write End	0		ns
t_{LZWE}	\overline{WE} HIGH to Low Z ^[5]	5		ns
t_{HZWE}	\overline{WE} LOW to High Z ^[5, 6]		25	ns

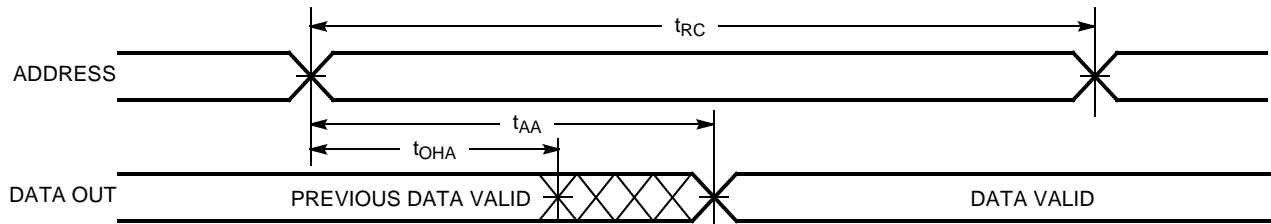
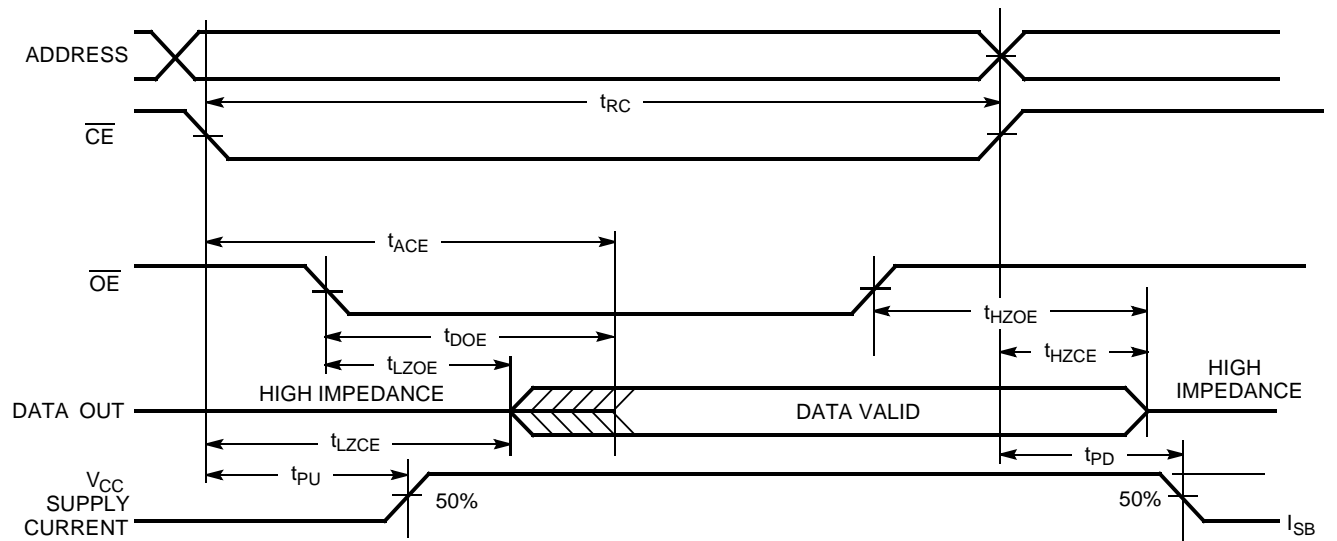
Notes:

- Test conditions assume signal transition time of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 100-pF load capacitance.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE} , t_{HZOE} is less than t_{LZOE} , and t_{HZWE} is less than t_{LZWE} for any given device.
- t_{HZOE} , t_{HZCE} , and t_{HZWE} are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ± 500 mV from steady-state voltage.
- The internal write time of the memory is defined by the overlap of \overline{CE} LOW, and \overline{WE} LOW. \overline{CE} and \overline{WE} must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.

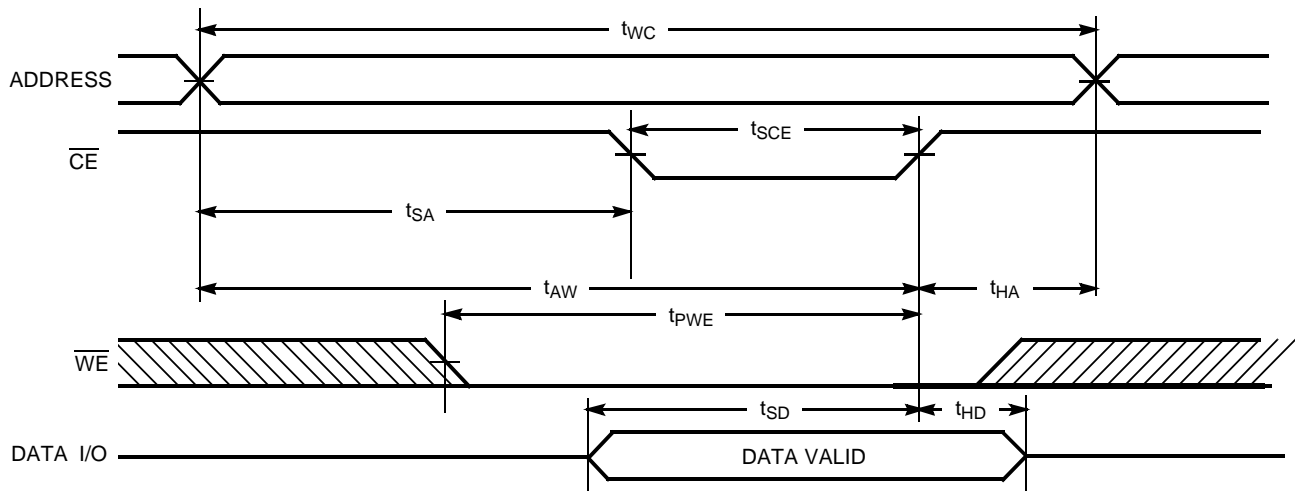
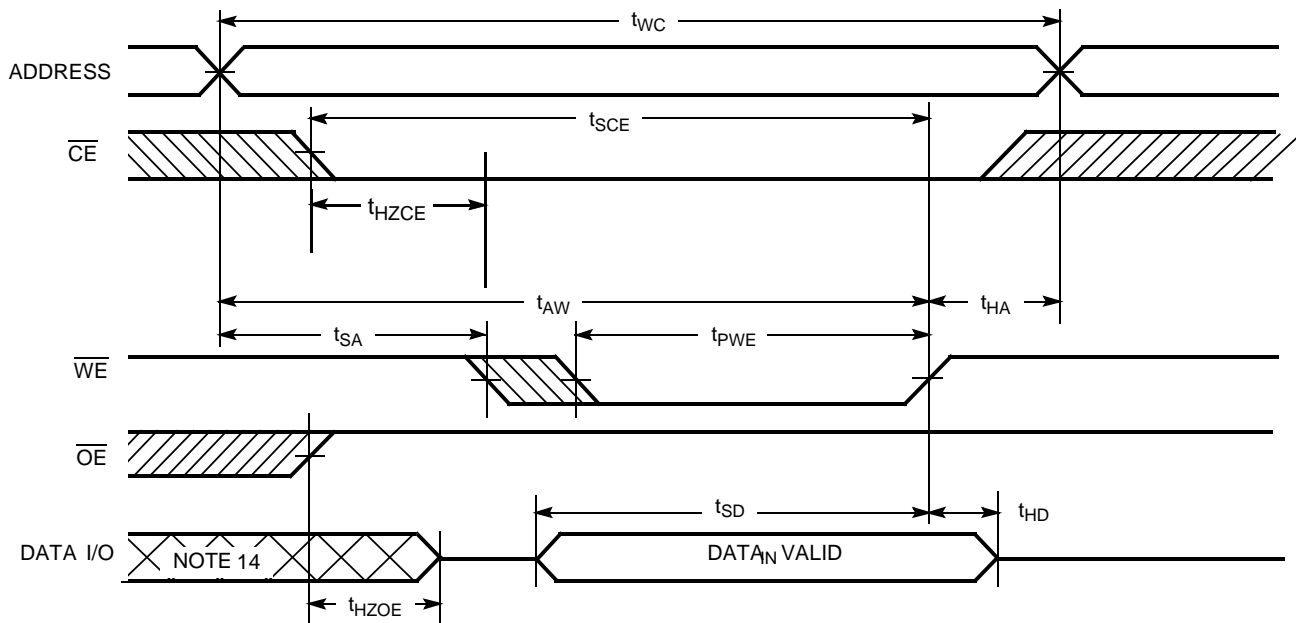
Data Retention Characteristics (Over the Operating Range)

Parameter	Description	Conditions	Min.	Typ. ^[2]	Max.	Unit
V_{DR}	V_{CC} for Data Retention		2.0			V
I_{CCDR}	Data Retention Current	No input may exceed $V_{CC} + 0.3V$ $V_{CC} = V_{DR} = 3.0V$ $CE > V_{CC} - 0.3V$ $V_{IN} > V_{CC} - 0.3V$ or $V_{IN} < 0.3V$			20	μA
$t_{CDR}^{[3]}$	Chip Deselect to Data Retention Time		0			ns
$t_R^{[8]}$	Operation Recovery Time		t_{RC}			ns

Data Retention Waveform


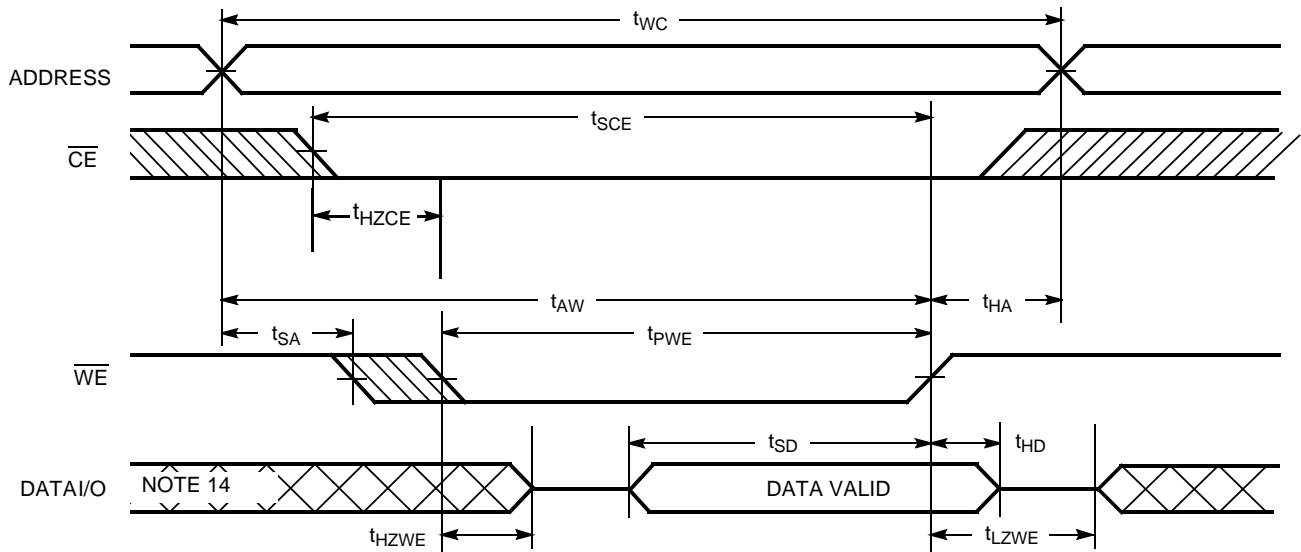
Switching Waveforms
Read Cycle No.1^[9, 10]

Read Cycle No. 2 ($\overline{\text{OE}}$ Controlled)^[10, 11]

Notes:

8. Full Device operatin requires linear V_{CC} ramp from V_{DR} to $V_{CC(min)}$ $\geq 100 \mu s$ or stable at $V_{cc(min)}$ $\geq 100 \mu s$.
9. Device is continuously selected. $\overline{\text{OE}}, \overline{\text{CE}} = V_{IL}$.
10. $\overline{\text{WE}}$ is HIGH for read cycle.
11. Address valid prior to or coincident with $\overline{\text{CE}}$ transition LOW.

Switching Waveforms (continued)
Write Cycle No. 1 (\overline{CE} Controlled)^[12]

Write Cycle No. 2 (\overline{WE} Controlled, \overline{OE} HIGH During Write)^[12, 13]

Notes:

12. If \overline{CE} goes HIGH simultaneously with \overline{WE} going HIGH, the output remains in a high-impedance state.
13. Data I/O is high-impedance if $\overline{OE} = V_{IH}$.
14. During this period the I/Os are in the output state and input signals should not be applied.

Switching Waveforms (continued)

Write Cycle No.3 (\overline{WE} Controlled, \overline{OE} LOW)^[12, 13]

Truth Table

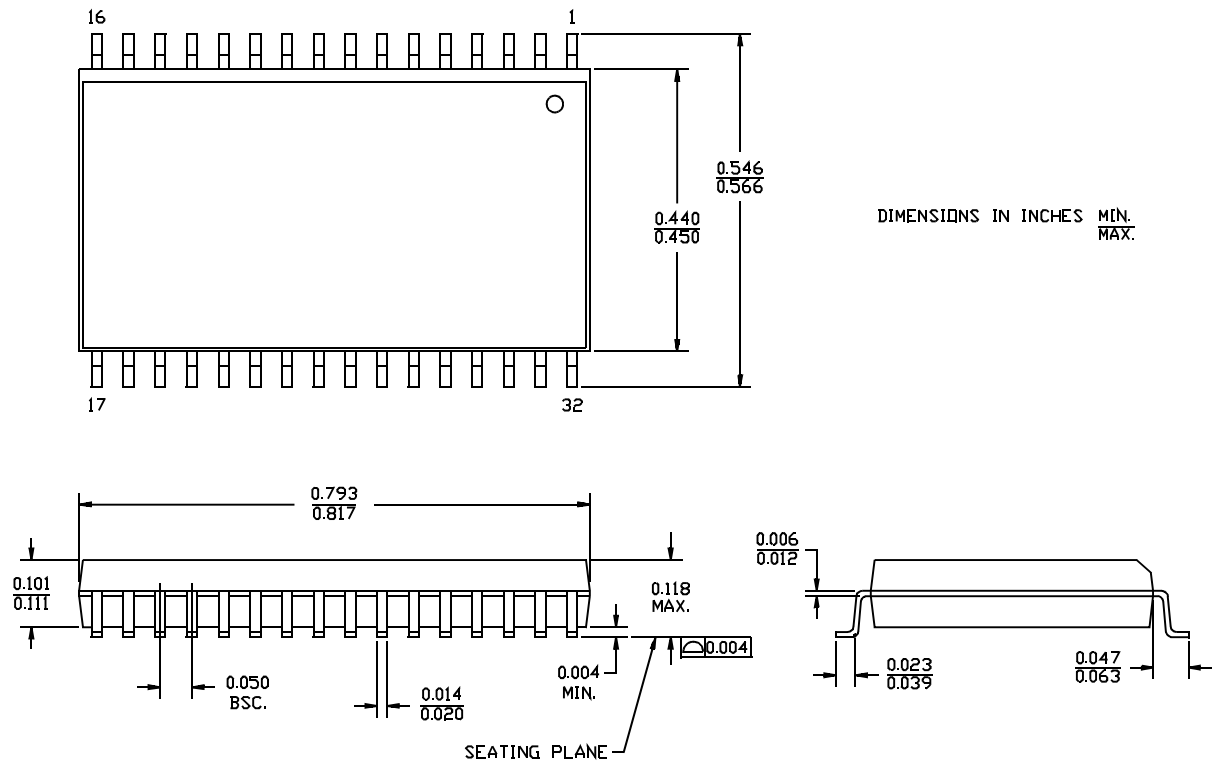
\overline{CE}	\overline{OE}	\overline{WE}	I/O ₀ - I/O ₇	Mode	Power
H	X	X	High Z	Power-Down	Standby (I_{SB})
L	L	H	Data Out	Read	Active (I_{CC})
L	X	L	Data In	Write	Active (I_{CC})
L	H	H	High Z	Selected, Outputs Disabled	Active (I_{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
70	WCMA4008C1X-GF70	G32	32-Lead (450-Mil) Molded SOIC	Industrial

Package Diagrams

32-Lead (450 MIL) Molded SOIC, G32



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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.